

HVD191

Silicon Epitaxial Planar Pin Diode for High Frequency Attenuator

REJ03G0015-0200 Rev.2.00 Jan 20, 2006

Features

- Low capacitance. (C = 0.37 pF max)
- Low forward resistance. (rf = $2.5 \Omega \text{ max}$)
- Super small Flat Lead Package (SFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Name	Package Code	
HVD191	H2	SFP	PUSF0002ZB-A	

Pin Arrangement

1 [Cathode mark Mark H2 2	1. Cathode
		2. Anode



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Reverse voltage	V _R	30	V
Forward current	I _F	100	mA
Power dissipation	Pd	150	mW
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	℃

Electrical Characteristics

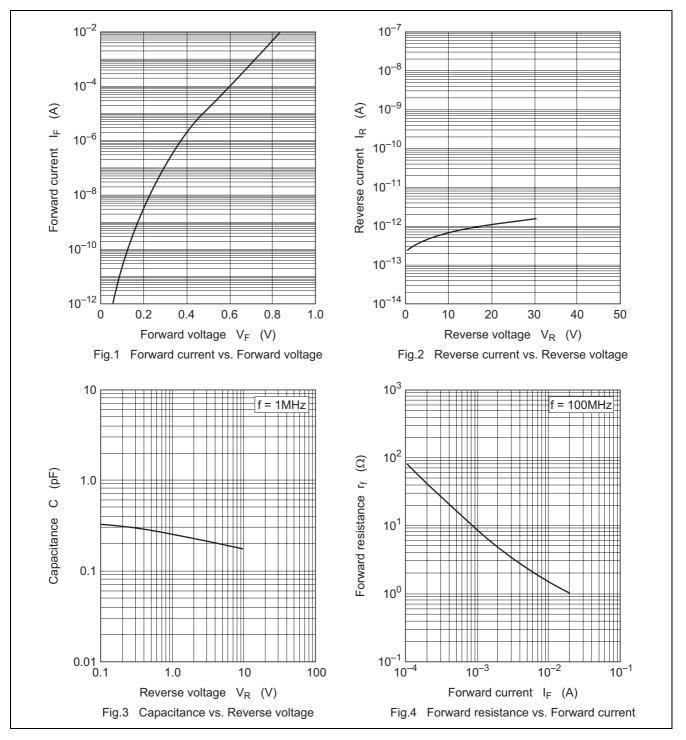
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V _F	_		1.0	V	I _F = 10 mA
Reverse current	I _R	_	—	100	nA	V _R = 30 V
Capacitance	С	_	—	0.37	pF	$V_R = 1 V$, f = 1 MHz
Forward resistance	r _f		_	2.5	Ω	I _F = 10 mA, f = 100 MHz

Note: For SFP package, the material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

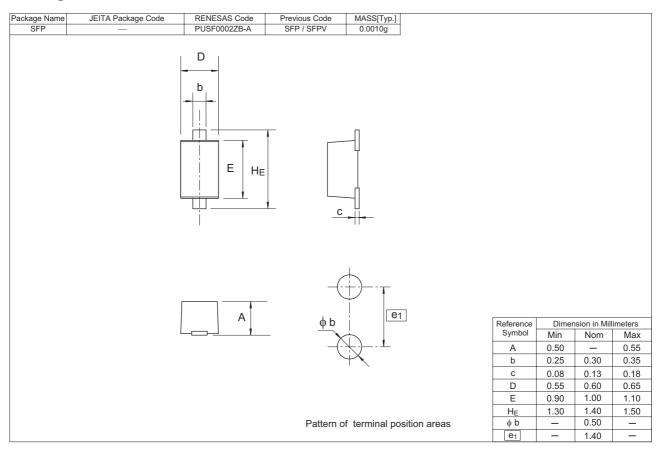


Main Characteristic





Package Dimensions





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